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Vertical External Cavity Surface Emitting Lasers (VECSELs) III

Jennifer E. Hastie
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Contents

vii *Conference Committee*

SESSION 1 POWER SCALING I

- 8606 02 **Design of high-efficiency semiconductor disk lasers (Invited Paper)** [8606-1]
P. Unger, A. Hein, F. Demaria, S. Menzel, M. Rampp, A. Ziegler, Ulm Univ. (Germany)
- 8606 04 **High power (23W) vertical external cavity surface emitting laser emitting at 1180 nm (Invited Paper)** [8606-3]
T. Leinonen, S. Ranta, M. Tavast, Tampere Univ. of Technology (Finland); R. Epstein, G. Fetzer, Sandalphon, N. Van Lieu, Areté Associates (United States); M. Guina, Tampere Univ. of Technology (Finland)

SESSION 2 ULTRAFAST VECSELS I: HIGH AVERAGE POWER

- 8606 05 **Passively mode-locked femtosecond VECSELS with high average output power (Invited Paper)** [8606-4]
M. Scheller, A. Laurain, College of Optical Sciences, The Univ. of Arizona (United States); S. W. Koch, Philipps-Univ. Marburg (Germany); J. V. Moloney, College of Optical Sciences, The Univ. of Arizona (United States)
- 8606 06 **Characterization of nonlinear gain parameters in VECSELS to optimize femtosecond high average power operation (Invited Paper)** [8606-5]
M. Mangold, V. J. Wittwer, O. D. Sieber, M. Hoffmann, M. Golling, T. Südmeyer, U. Keller, ETH Zurich (Switzerland)
- 8606 07 **Towards VECSEL frequency combs (Invited Paper)** [8606-6]
K. G. Wilcox, Univ. of Southampton (United Kingdom)
- 8606 08 **Supercontinuum generation with femtosecond pulse fiber amplified VECSELS** [8606-7]
C. R. Head, H.-Y. Chan, J. S. Feehan, D. P. Shepherd, S. Alam, A. C. Tropper, J. H. V. Price, K. G. Wilcox, Univ. of Southampton (United Kingdom)

SESSION 3 INTRACAVITY TECHNIQUES

- 8606 0A **Intracavity-enhanced laser cooling of solids using high power VECSELS at 1020 nm (Invited Paper)** [8606-9]
M. Sheik-Bahae, M. Ghasemkhani, A. R. Albrecht, The Univ. of New Mexico (United States); D. V. Seletskiy, Univ. of Konstanz (Germany); J. G. Cederberg, Sandia National Lab. (United States); S. D. Melgaard, The Univ. of New Mexico (United States)

- 8606 0B **30W peak-power 3ns pulse-width operation of a 2 μ m electro-optically cavity-dumped VECSEL** [8606-10]
S. Kaspar, M. Rattunde, T. Töpfer, S. Adler, U. T. Schwarz, C. Manz, K. Köhler, J. Wagner, Fraunhofer-Institut für Angewandte Festkörperphysik (Germany)

SESSION 4 SPECTRAL COVERAGE

- 8606 0D **Investigation of InAs quantum dashes for 1.45-2.1 μ m vertical external cavity surface emitting laser active regions** [8606-12]
T. J. Rotter, P. Ahirwar, D. M. Shima, S. J. Addamane, C. P. Hains, L. R. Dawson, G. Balakrishnan, The Univ. of New Mexico (United States)
- 8606 0E **TEM based analysis of III-Sb VECSELS on GaAs substrates for improved laser performance** [8606-13]
P. Ahirwar, D. Shima, T. J. Rotter, S. P. R. Clark, S. J. Addamane, C. P. Hains, L. R. Dawson, G. Balakrishnan, The Univ. of New Mexico (United States); R. Bedford, Air Force Research Lab. (United States); Y. Y. Lai, A. Laurain, J. Hader, J. V. Moloney, College of Optical Sciences, The Univ. of Arizona (United States)

SESSION 5 ELECTRICAL PUMPING AND DEVICE PACKAGING

- 8606 0F **Recent progress in wafer-fused VECSELS emitting in the 1310nm and 1550nm bands (Invited Paper)** [8606-14]
A. Sirbu, A. Caliman, A. Mereuta, K. Pierscinski, Ecole Polytechnique Fédérale de Lausanne (Switzerland); A. Rantamäki, J. Lyytikäinen, J. Rautiainen, Tampere Univ. of Technology (Finland); V. Iakovlev, N. Volet, Ecole Polytechnique Fédérale de Lausanne (Switzerland); O. Okhotnikov, Tampere Univ. of Technology (Finland); E. Kapon, Ecole Polytechnique Fédérale de Lausanne (Switzerland)
- 8606 0G **Passively modelocked electrically pumped VECSELS (Best Paper Award)** [8606-15]
C. A. Zaugg, W. P. Pallmann, M. Mangold, V. J. Wittwer, ETH Zurich (Switzerland); H. Moench, S. Gronenborn, Philips Technologie GmbH Photonics (Germany); M. Miller, Philips Technologie GmbH U-L-M Photonics (Germany); B. W. Tilma, T. Südmeyer, U. Keller, ETH Zurich (Switzerland)
- 8606 0H **Analysis of single-mode efficiency of electrically pumped VECSELS** [8606-16]
T. Schwarz, M. Berens, RWTH Aachen Univ. (Germany); S. Gronenborn, J. Kolb, Philips Technologie GmbH Photonics (Germany); P. Loosen, RWTH Aachen Univ. (Germany) and Fraunhofer-Institut für Lasertechnik (Germany); M. Miller, Philips Technologie GmbH U-L-M Photonics (Germany); H. Mönch, Philips Technologie GmbH Photonics (Germany); R. Wester, Fraunhofer-Institut für Lasertechnik (Germany)
- 8606 0I **Automated assembly of VECSEL components** [8606-17]
C. Brecher, N. Pyschny, S. Haag, T. Mueller, Fraunhofer-Institut für Produktionstechnologie (Germany)

SESSION 6 POWER SCALING II: THERMAL MANAGEMENT

- 8606 0L **Effects of cryogenic temperatures on the performance of CW VECSELS** [8606-20]
O. J. Morris, K. G. Wilcox, C. R. Head, A. P. Turnbull, Univ. of Southampton (United Kingdom);
I. Farrer, H. E. Beere, D. A. Ritchie, Univ. of Cambridge (United Kingdom); A. C. Tropper,
Univ. of Southampton (United Kingdom)

SESSION 7 ULTRAFast VECSELS II

- 8606 0M **Self mode locked OPSL: role of high-order modes in starting self-mode-locked operation (Invited Paper)** [8606-21]
H. C. Liang, Y. C. Lee, J. C. Tung, K. W. Su, Y. F. Chen, K. F. Huang, National Chiao Tung Univ. (Taiwan)
- 8606 0N **Advances in mode-locked semiconductor disk lasers (Invited Paper)** [8606-22]
L. Kornaszewski, N. Hempler, C. J. Hamilton, G. T. Maker, G. P. A. Malcolm, M Squared Lasers Ltd. (United Kingdom)
- 8606 0O **Generation of 200-fs pulses with a short microcavity VECSEL** [8606-23]
A. P. Turnbull, K. G. Wilcox, C. R. Head, O. J. Morris, Univ. of Southampton (United Kingdom);
I. Farrer, D. A. Ritchie, Univ. of Cambridge (United Kingdom); A. C. Tropper, Univ. of Southampton (United Kingdom)
- 8606 0P **Exploring spatio-temporal dynamics of an optically pumped semiconductor laser with intracavity second harmonic generation** [8606-24]
Y. C. Lee, H. C. Liang, J. C. Tung, K. W. Su, Y. F. Chen, K. F. Huang, National Chiao Tung Univ. (Taiwan)

SESSION 8 SINGLE FREQUENCY

- 8606 0Q **Noise properties of NIR and MIR VECSELS (Invited Paper)** [8606-25]
M. Myara, M. Sellahi, Institut d'Electronique du Sud, CNRS, Univ. Montpellier 2 (France);
A. Laurain, Institut d'Electronique du Sud, CNRS, Univ. Montpellier 2 (France) and College of Optical Sciences, The Univ. of Arizona (United States); A. Michon, Ctr. de Recherche sur l'Hétéro-Epitaxie et ses Applications, CNRS (France) and Lab. de Photonique et de Nanostructures, CNRS (France); I. Sagnes, Lab. de Photonique et de Nanostructures, CNRS (France); A. Garnache, Institut d'Electronique du Sud, CNRS, Univ. Montpellier 2 (France)
- 8606 0R **Optically pumped external-cavity semiconductor lasers for precision spectroscopy and laser cooling of atomic Hg (Invited Paper)** [8606-26]
J. R. Paul, C. R. Lytle, Y. Kaneda, J. Moloney, T.-L. Wang, R. J. Jones, College of Optical Sciences, The Univ. of Arizona (United States)

- 8606 OS **Tunable high-purity microwave signal generation from a dual-frequency VECSEL at 852 nm** [8606-28]
F. A. Camargo, Lab. Charles Fabry, CNRS, Univ. Paris-Sud XI (France); N. Girard, Thales Research and Technology (France); J. M. Danet, LNE-SYRTE, CNRS, Observatoire de Paris (France); G. Baili, L. Morvan, D. Dolfi, Thales Research and Technology (France); D. Holleville, S. Guérandel, LNE-SYRTE, CNRS, Observatoire de Paris (France); I. Sagnes, Lab. de Photonique et de Nanostructures, CNRS (France); P. Georges, G. Lucas-Leclin, Lab. Charles Fabry, CNRS, Univ. Paris-Sud XI (France)

POSTER SESSION

- 8606 OT **Efficient thermoelectric cooling of concentrated heat loads** [8606-27]
J. Hershberger, R. Smythe, Laird Technologies (United States); X. Gu, Laird Technologies (China); R. F. Hill, Laird Technologies (United States)

Author Index

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- 1 Power Scaling I
Jerome V. Moloney, The University of Arizona (United States)
- 2 Ultrafast VECSELS I: High Average Power
Ursula Keller, ETH Zurich (Switzerland)

- 3 Intracavity Techniques
Jennifer E. Hastie, University of Strathclyde (United Kingdom)
- 4 Spectral Coverage
Mircea Guina, Tampere University of Technology (Finland)
- 5 Electrical Pumping and Device Packaging
John-Mark Hopkins, University of Strathclyde (United Kingdom)
- 6 Power Scaling II: Thermal Management
Juan L. Chilla, Coherent, Inc. (United States)
- 7 Ultrafast VECSELS II
Anne C. Tropper, University of Southampton (United Kingdom)
- 8 Single Frequency
Alexei Sirbu, Ecole Polytechnique Fédérale de Lausanne
(Switzerland)